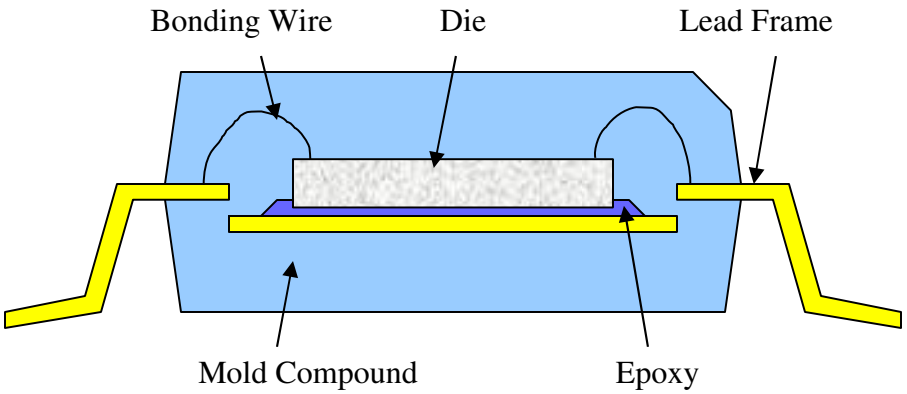
Doc: A

Cross-Section View VS1011E
28pin SOIC (RoHS) Package



Device name: VS1011E-S/LSR-ROHS
Marking on device: VS1011E R

Lead Frame

Plate composition	**100% Sn**
Plate thickness	**400 +/- 30 micro inches average**

Material

Lead Frame	**A194 (Samsung)**
Epoxy Die Attach	**CRM 1076NS (Sumitomo)**
Bonding Wire	**1.0 mil Au (KNS)**
Mold Compound	**EME G700LX (Sumitomo)**